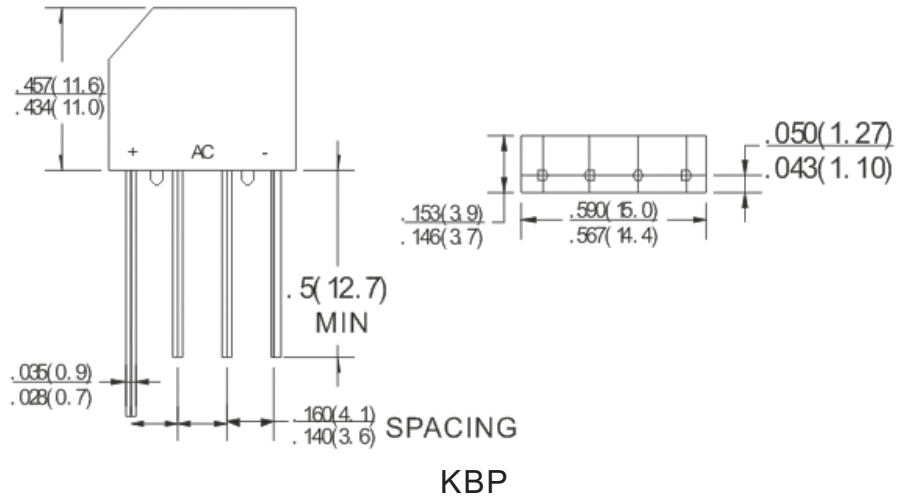


**FEATURES**

- Reverse voltage 50 to 1000 volts
- Glass passivated chip junction
- UL Recognized
- High surge forward current capability
- Low reverse leakage current

**MECHANICAL DATA**

- Molded plastic body (UL 94V-0 reted)
- Lead: solder plated
- Polarity: As marked



Dimensions in inches and (millimeters)

**MAXIMUM RATINGS & ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	KBP2005	KBP201	KBP202	KBP204	KBP206	KBP208	KBP210	Unit
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current, @T <sub>C</sub> =30°C	I <sub>O (AV)</sub>	2							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	60							A
I <sup>2</sup> t Rating for fusing (1ms ≤ t < 8.3ms)	I <sup>2</sup> t	15							A <sup>2</sup> S
Peak Forward Voltage@1.5A	V <sub>F</sub>	1.1							V
Maximum DC Reverse Current at rated DC Blocking voltage Per Element	I <sub>R</sub>	10							μA
Typical Thermal Resistance (Note)	R <sub>θJA</sub>	30							°C/W
Operating Temperature Range	T <sub>J</sub>	-50 to + 150							°C
Storage Temperature Range	T <sub>STG</sub>	-50 to + 150							°C

**NOTE:** Thermal Resistance from Junction to Case on PCB with 0.47 x 0.47" (12x12mm) Copper

**RATING & CHARACTERISTIC CURVES**

FIG.1-MAXIMUM CURRENT DERATING CURVE

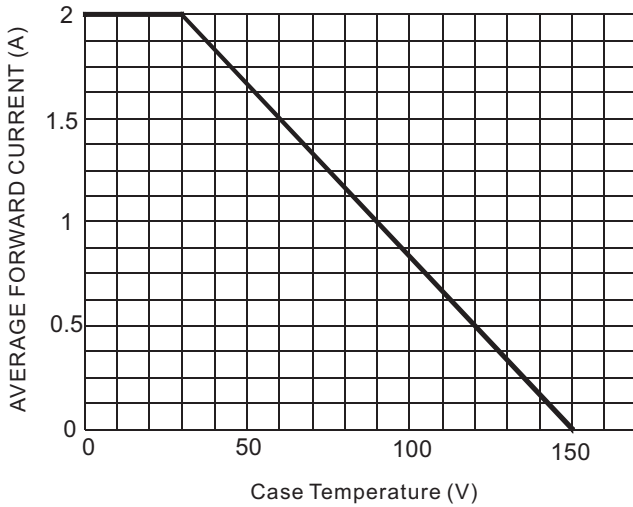


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

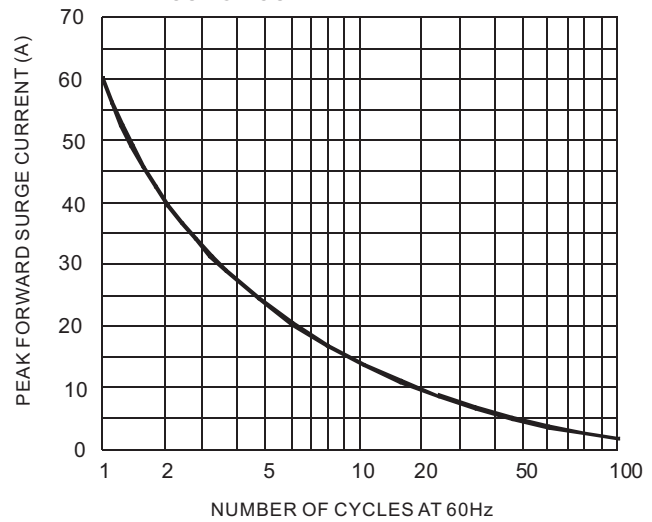


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

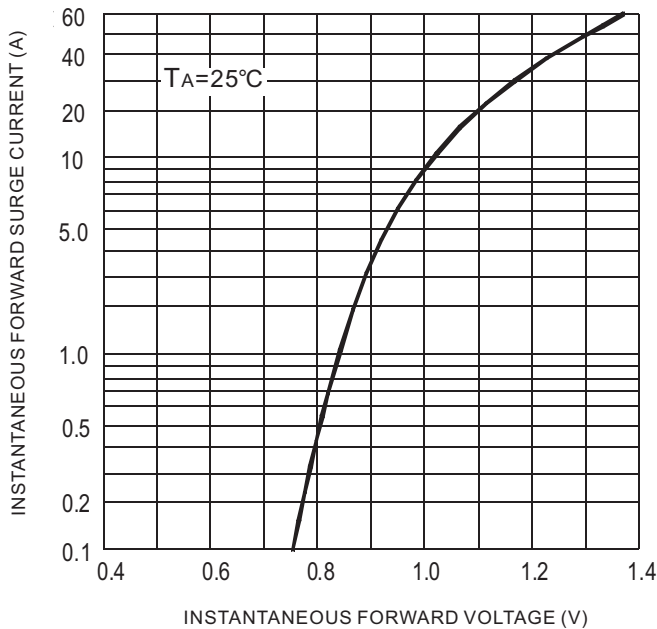


FIG.4-TYPICAL REVERSE CHARACTERISTICS

